

HiTemp ET Series Thermoelectric Cooler

The ET4-7-F1-2323-TA-RT-W4.5 high temperature Thermoelectric Cooler uses Laird's enhanced Thermoelectric Module construction preventing performance degrading copper diffusion, which is common in standard grade TEMs operating in high temperature environments exceeding 80 °C. It has a maximum Qc of 19.6 Watts when $\Delta T=0$ and a maximum ΔT of 77.9 °C at Qc = 0.

Features

- High-temperature operation
- Reliable solid-state
- No sound or vibration
- Environmentally-friendly RoHS-compliant

Applications

Ceramic Matérial: Alumina (Al2O3)

Solder Construction: 232°C, SbSn

- Peltier Cooling for Refrigerated Centrifuges
- Peltier Cooling for Machine Vision
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems

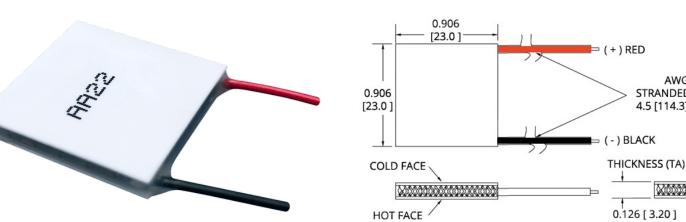
AWG 24

STRANDED TEFLON

4.5 [114.3] LENGTH

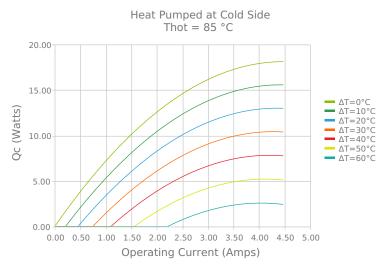
INCHES [MM]

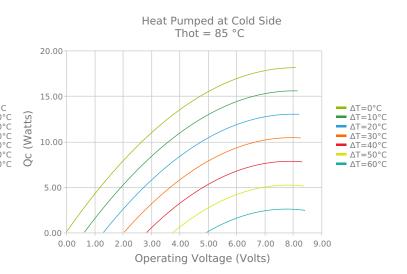
• Peltier Cooling for Digital • Light Processors

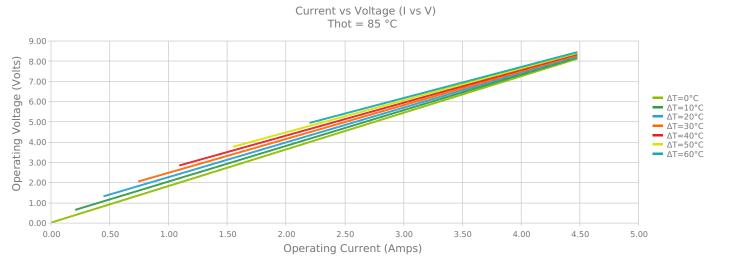


Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

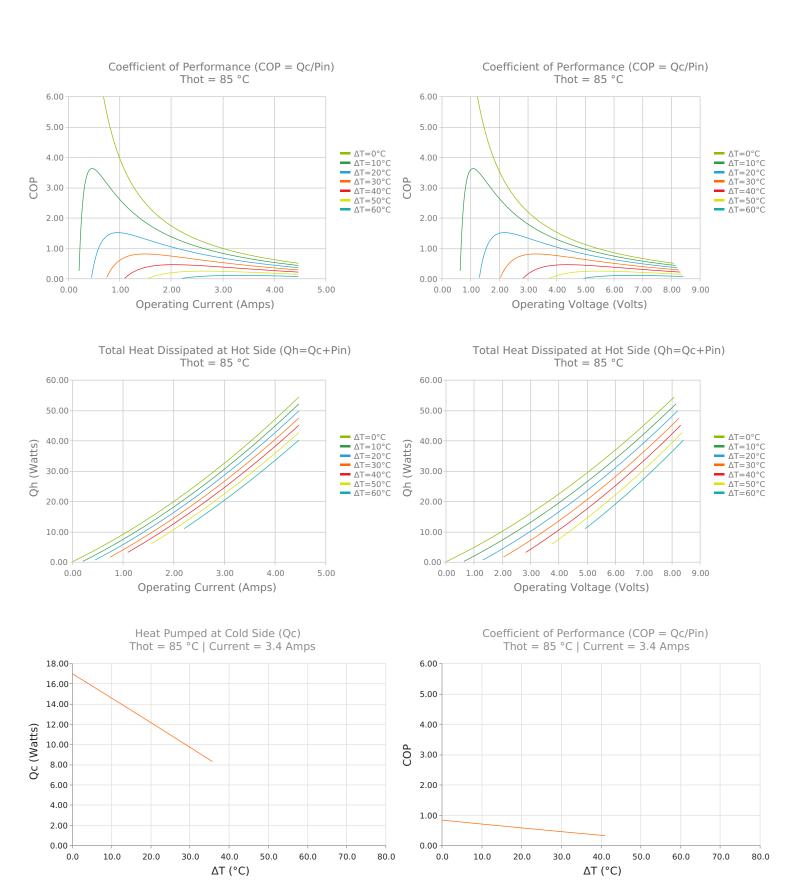
ELECTRICAL AND THERMAL PERFORMANCE













SPECIFICATIONS*

Hot Side Temperature

 $Qcmax (\Delta T = 0)$

 $\Delta T max (Qc = 0)$

Imax (I @ \Darkstyle Tmax)

Vmax (V @ ΔTmax)

Module Resistance

Max Operating Temperature

Weight

50.0 °C	85.0 °C	110.0 °C	
19.6 Watts	21.5 Watts	22.5 Watts	
77.9°C	89.3°C 96.2°C		
3.9 Amps	3.8 Amps	3.7 Amps	
8.5 Volts	9.8 Volts	10.7 Volts	
2.03 Ohms	2.35 Ohms	2.58 Ohms	
150 °C			
6.0 gram(s)			

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
11	3.200 ±0.051 mm 0.126 ± 0.002 in	0.051 mm / 0.051 mm 0.002 in / 0.002 in	Lapped	Lapped	50.8 mm 2.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
RT	RTV	White	-60 to 204°C	Non-corrosive, silicone adhesive

NOTES

- 1. Max operating temperature: 150°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation

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^{*} Specifications reflect thermoelectric coefficients updated March 2020